NCE N-Channel Enhancement Mode Power MOSFET

Description

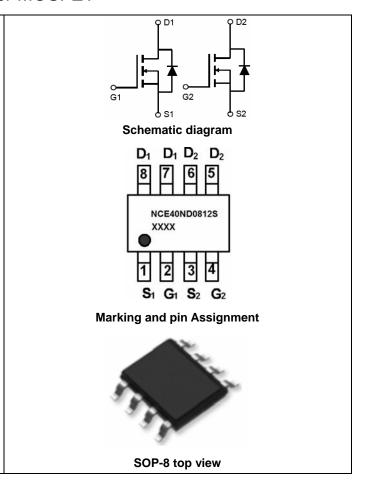
The NCE40ND0812S uses advanced trench technology and design to provide excellent $R_{\text{DS(ON)}}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $\begin{array}{lll} \bullet & V_{DS} = \!\! 40 V, I_D = \!\! 8A & V_{DS} = \!\! 40 V, I_D = \!\! 12A \\ & R_{DS(ON)} < 18 m\Omega @ V_{GS} = \!\! 10V & R_{DS(ON)} < 14 m\Omega @ V_{GS} = \!\! 10V \\ & R_{DS(ON)} < 28 m\Omega @ V_{GS} = \!\! 4.5V & R_{DS(ON)} < 20 m\Omega @ V_{GS} = \!\! 4.5V \end{array}$
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE40ND0812S	NCE40ND0812S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Parame	ter	Symbol	N1-Channel	N2-Channel	Unit
Drain-Source Voltage		V _{DS}	40	40	V
Gate-Source Voltage		V _{GS}	±20	±20	V
Continuous Drain Current	T _C =25℃	1	8	12	Α
Continuous Drain Current	T _C =100℃	I _D	5.7	8.5	A
Pulsed Drain Current (Note 1)		I _{DM}	32	60	Α
Maximum Power Dissipation	T _C =25℃	P _D	2	2.5	W
Operating Junction and Storage Te	mperature Range	T _J ,T _{STG}	-55 ⁻	To 150	$^{\circ}$ C

Thermal Characteristic

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction-to-Ambient (Note 2) (N1-Channel)	$R_{\theta JA}$	62.5	85	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2) (N2-Channel)	R _{0JA}	50	75	°C/W



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N1-CH Electrical Characteristics (T_A=25 ^oC unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	40	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)				•		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.5	2.0	V
Drain-Source On-State Resistance	D	V _{GS} =10V, I _D =8A	-	15.8	18	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =4A	-	22	28	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =8A	33	-	-	S
Dynamic Characteristics (Note4)			•	•		•
Input Capacitance	C _{lss}	V _{DS} =20V,V _{GS} =0V,	-	964	-	PF
Output Capacitance	Coss	V _{DS} -20V,V _{GS} -0V, F=1.0MHz	-	109	-	PF
Reverse Transfer Capacitance	C _{rss}	r = 1.0ivii 12	-	96	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	5.5	-	nS
Turn-on Rise Time	t _r	V_{DD} =20V, R_L =2.5 Ω	-	14	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =10 V , R_{GEN} =3 Ω	-	24	-	nS
Turn-Off Fall Time	t _f		-	12	-	nS
Total Gate Charge	Qg	\/ -20\/ -0.4	-	22.9	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =20V, I_{D} =8A, V_{GS} =10V	-	3.5	-	nC
Gate-Drain Charge	Q_{gd}	VGS-10V	-	5.3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS} =0 V , I_{S} =8 A	-	0.8	1.2	V
	•					

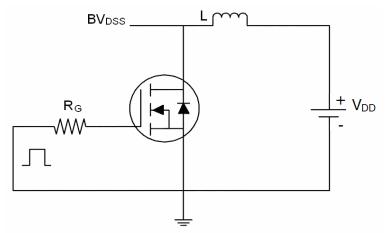
Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. The value of R $_{\theta JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25°C. The value in any given application depends on the user's specific board design. Surface Mounted on FR4 Board, t \leq 10 sec. The current rating is based on the t \leq 10s thermal resistance rating.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production.

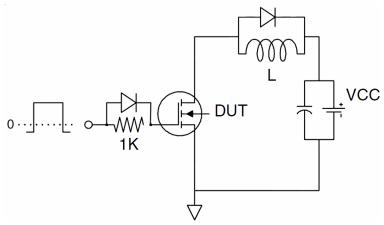


Test Circuit

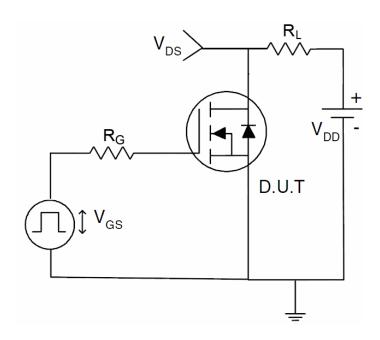
1) E_{AS} Test Circuits



2) Gate Charge Test Circuit:



3) Switch Time Test Circuit:





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N1- Channel Typical Electrical and Thermal Characteristics (Curves)

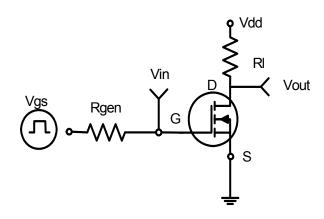


Figure 1:Switching Test Circuit

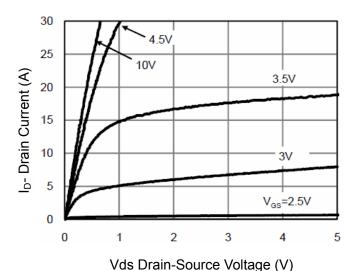


Figure 3 Output Characteristics

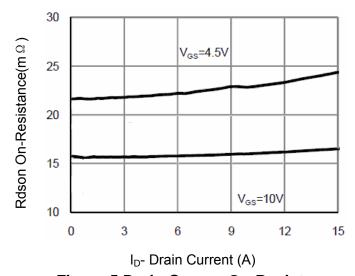


Figure 5 Drain-Source On-Resistance

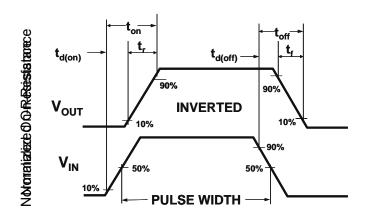


Figure 2:Switching Waveforms

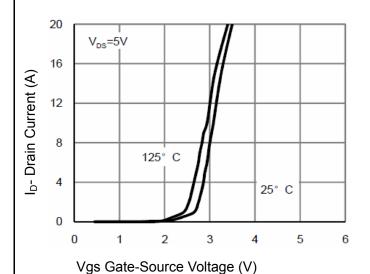


Figure 4 Transfer Characteristics

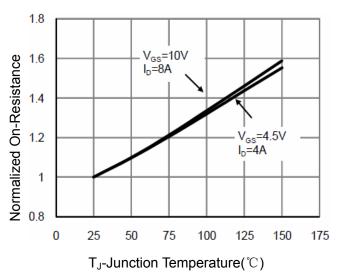
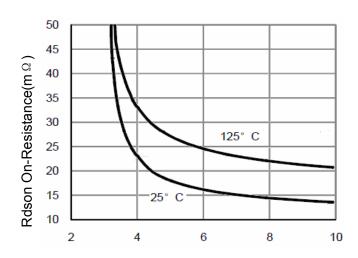


Figure 6 Drain-Source On-Resistance





Vgs Gate-Source Voltage (V)

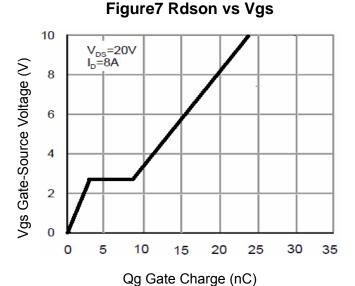


Figure 9 Gate Charge

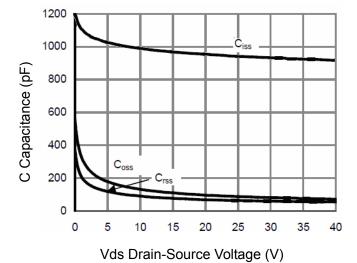
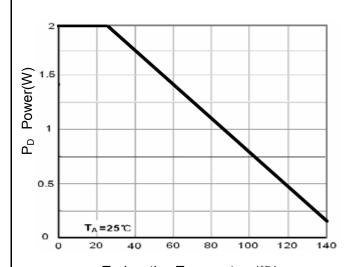


Figure 11 Capacitance vs Vds



 T_J -Junction Temperature($^{\circ}$ C) Figure 8 Power Dissipation

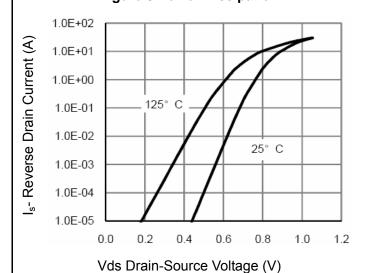
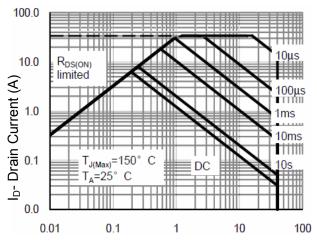


Figure 10 Source- Drain Diode Forward



Vds Drain-Source Voltage (V)

Figure 12 Safe Operation Area



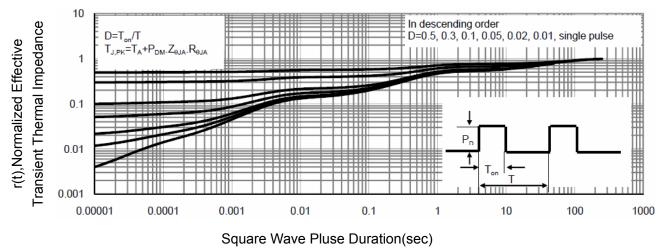


Figure 13 Normalized Maximum Transient Thermal Impedance



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N2-CH Electrical Characteristics (T_A=25 ^oC unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u> </u>					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	40	45	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.6	2.5	V
Drain Course On State Besistance	Б	V _{GS} =10V, I _D =10A	-	11.7	14	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =8A	-	15.6	20	mΩ
Forward Transconductance g _F		V _{DS} =5V,I _D =10A		75	-	S
Dynamic Characteristics (Note4)	<u> </u>					
Input Capacitance	C _{lss}		-	1780	-	PF
Output Capacitance	C _{oss}	V_{DS} =20V, V_{GS} =0V,	-	209	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	160	-	PF
Switching Characteristics (Note 4)	<u> </u>					
Turn-on Delay Time	t _{d(on)}		-	6.4	-	nS
Turn-on Rise Time	t _r	V_{DD} =20 V , R_L =2 Ω	-	17.2	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	29.6	-	nS
Turn-Off Fall Time	t _f		-	16.8	-	nS
Total Gate Charge	Qg	\/ 00\/ L 40A	-	38.2		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=20V,I_{D}=10A,$	-	5.6		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	7.4		nC
Drain-Source Diode Characteristics	1					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	12	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 10A	-	29	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	26	-	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

N2-Typical Electrical and Thermal Characteristics (Curves)

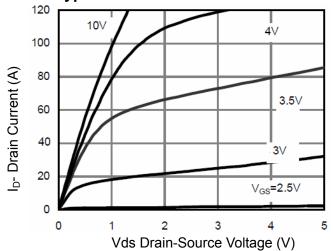


Figure 1 Output Characteristics

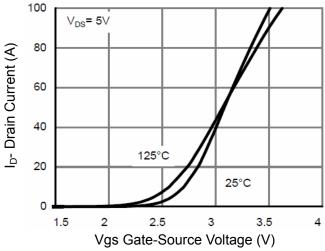
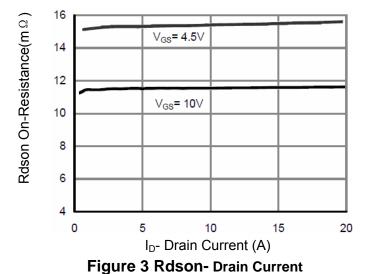


Figure 2 Transfer Characteristics



V_{GS}= 10V Normalized On-Resistance 1.6 I_D= 10A 1.4 I_D=8A 1.2 1.0 8.0 50 75 100 125 150 175 T_J -Junction Temperature($^{\circ}$ C)

Figure 4 Rdson-JunctionTemperature

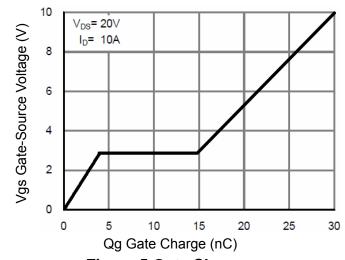


Figure 5 Gate Charge

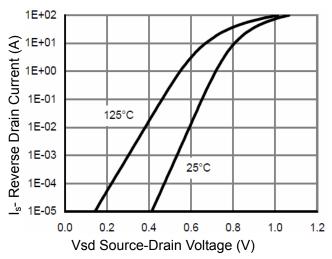
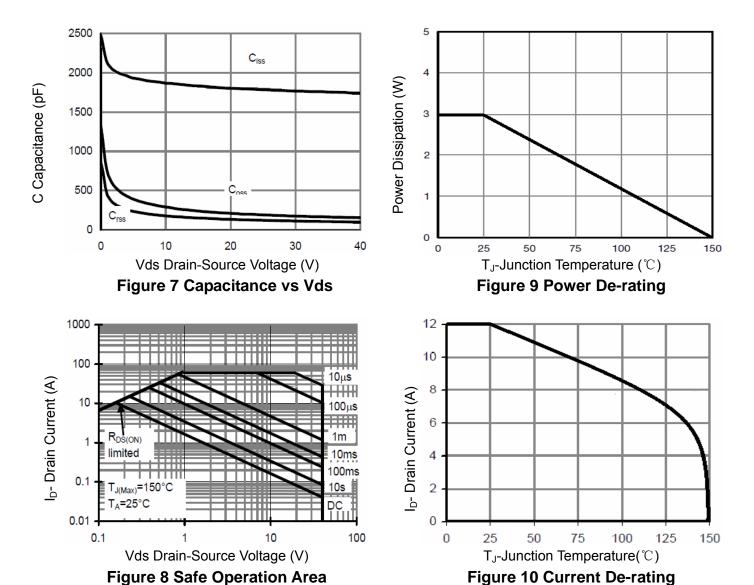
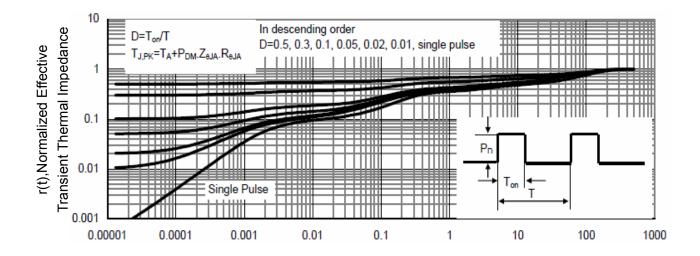


Figure 6 Source- Drain Diode Forward







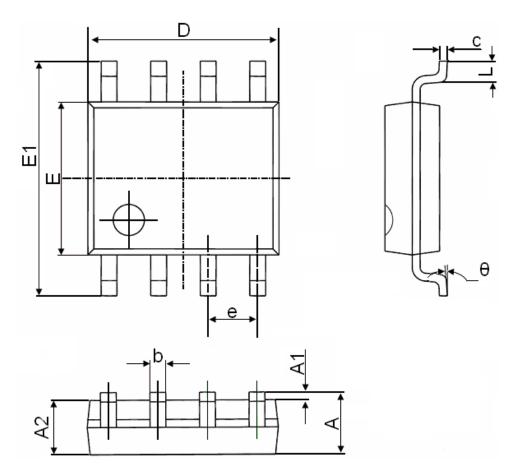
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





SOP-8 Package Information



Compleal	Dimensions I	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
Е	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(I	BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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